

**Amendments to the specification:**

Please insert the following paragraph between paragraphs [0034] and [0035] of Applicants' published specification.

-- In another embodiment, in order to arrange extensive electronics on a small area of the mount 1, an insulating layer 3a composed of a sintered polymer is arranged on the conductor track system 4 and on an electronic power component 8a. Additionally, a further conductor track system 4a that includes a sintered glass frit with noble metal filling is arranged on the insulating layer 3a, and an electronic power component 8b is arranged on the conductor track system 4a. --